

NI PXIe-6545

200MHz Digital Waveform Generator/Analyzer



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SPECIFICATIONS

PXIe-6545

200 MHz Digital Waveform Generator/Analyzer

This document provides the specifications for the PXIe-6545.



Hot Surface If the PXIe-6545 has been in use, it may exceed safe handling temperatures and cause burns. Allow the PXIe-6545 to cool before removing it from the chassis.



Note All values were obtained using a 1 m cable (SHC68-C68-D4 recommended). Performance specifications are not guaranteed when using longer cables.

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Definitions and Conditions

Specifications are valid for the range 0 °C to 55 °C unless otherwise noted.

Maximum and *minimum* specifications are warranted not to exceed these values within certain operating conditions and include the effects of temperature and uncertainty unless otherwise noted.

Typical specifications are unwarranted values that are representative of a majority (3σ) of units within certain operating conditions and include the effects of temperature and uncertainty unless otherwise noted.

Characteristic specifications are unwarranted values that are representative of an average unit operating at room temperature.

Nominal specifications are unwarranted values that are relevant to the use of the product and convey the expected performance of the product.

All specifications are Typical unless otherwise noted.

Channels

Data

Number of channels	32, single data rate (SDR) ¹
Direction control	Per channel Per operation
Time to tristate (t _{pZ}), 2 kΩ and 15 pF load	6.2 ns, nominal
Programmable Function Interface (PFI)	
Number of channels	4
Direction control	Per channel

¹ Using SDR, data is clocked using the rising or falling edge of the Sample clock.

Clock terminals	
Input	2
Output	2

Related Information

[Triggers](#) on page 20

[Events](#) on page 22

[CLK IN](#) on page 15

[CLK OUT](#) on page 17

Generation Channels

Channels	Data DDC CLK OUT PFI <0..3>
Generation signal type	Single-ended
DC generation voltage accuracy ²	±35 mV, typical ±200 mV, maximum

² Into 1 MΩ; does not include system crosstalk.

Table 1. Generation Voltage Levels

Logic Family ³	Voltage Low Level (V _{OL})		Voltage High Level (V _{OH})		Accuracy for Nominal Values into 1 MΩ Load
	Nominal	Max	Min	Nominal	
1.2 V (V _{OH} = 1.2 V)	0.0 V	0.2 V	1 V	1.2 V	±35 mV, typical
1.5 V (V _{OH} = 1.5 V)			1.3 V	1.5 V	
1.8 V (V _{OH} = 1.8 V)			1.6 V	1.8 V	
2.5 V (V _{OH} = 2.5 V)			2.3 V	2.5 V	
3.3 V (V _{OH} = 3.3 V)			3.1 V	3.3 V	



Note Generation and acquisition sessions share a common voltage resource. Simultaneous operations must be set to the same logic family.

Output impedance	50 Ω, nominal
Maximum allowed DC drive strength per channel, by logic family	
1.2 V	±12 mA, nominal
1.5 V	±15 mA, nominal
1.8 V	±18 mA, nominal
2.5 V	±25 mA, nominal
3.3 V	±33 mA, nominal
Data channel driver enable/disable control	Software-selectable: per channel
Channel power-on state	Drivers disabled, 50 kΩ nominal input impedance

³ For all data, PFI, and clock channels. Does not include system crosstalk.

Output protection

Range	0 V to 5 V
Duration	Indefinite

Related Information

[CLK OUT](#) on page 17

[DDC CLK OUT](#) on page 18

Acquisition Channels

Channels	Data STROBE PFI <0..3>
Acquisition signal type	Single-ended
Accuracy ⁴	±150 mV, typical ±30%, maximum

Table 2. Acquisition Voltage Threshold Accuracy

Logic Family ⁵	Voltage Thresholds Low (V _{IL})		Voltage Thresholds High (V _{IH})	
	Minimum	Typical	Typical	Maximum
1.2 V (V _{IH} , V _{IL} = 0.60 V)	420 mV	450 mV	750 mV	780 mV
1.5 V (V _{IH} , V _{IL} = 0.75 V)	525 mV	600 mV	900 mV	975 mV
1.8 V (V _{IH} , V _{IL} = 0.90 V)	630 mV	750 mV	1.05 V	1.17 V
2.5 V (V _{IH} , V _{IL} = 1.25 V)	875 mV	1.10 V	1.40 V	1.625 V
3.3 V (V _{IH} , V _{IL} = 1.65 V)	1.155 V	1.50 V	1.80 V	2.145 V



Note Generation and acquisition sessions share a common voltage resource. Simultaneous operations must be set to the same logic family.

Input impedance	High-impedance (50 kΩ), nominal
Input protection ⁶	-1 V to 5 V

⁴ Does not include system crosstalk.
⁵ For all data, PFI, and clock channels. Does not include system crosstalk.
⁶ Internal diode clamps may begin conduction outside the -0.5 V to 3.5 V range.

Timing

Sample Clock

Sources	1. On Board clock (internal 800 MHz VCO with 32-bit DDS) 2. CLK IN (SMA jack connector) 3. STROBE (Digital Data & Control [DDC] connector; acquisition only)
Frequency range	
On Board clock	100 Hz to 200 MHz
CLK IN	20 kHz to 200 MHz
STROBE	100 Hz to 200 MHz
On Board clock characteristics	
Resolution ⁷	0.2 Hz, maximum
Accuracy ⁸	±150 ppm + 5 ppm per year
On Board clock characteristics valid only when PLL reference source is set to None	
Frequency accuracy	±150 ppm (including temperature effects), typical
Aging	±5 ppm first year, nominal
Sample clock relative delay adjustment ⁹	
Range	
Acquisition sessions	0.0 to 1.0 Sample clock periods
Generation sessions	0.0 ns to 5.0 ns
Resolution	0.5 ps
Exported Sample clock destinations	DDC CLK OUT (DDC connector) CLK OUT (SMA jack connector)
Exported Sample clock delay	
Range	0.0 to 1.0 Sample clock periods
Resolution (δ_C) ¹⁰	117 ps to 143 ps, nominal

⁷ Varies with Sample clock frequency. You can query NI-HSDIO for the programmed frequency value.

⁸ Accuracy may be increased by using a higher-performance external Reference clock.

⁹ You can apply a delay or phase adjustment to the On Board clock to align multiple devices.

¹⁰ Resolution is nonlinearly dependent on clock frequency. You can query clock frequency using NI-HSDIO.

Frequency	
On Board clock	All supported frequencies
External clock	Frequencies ≥ 20 MHz
Exported Sample clock jitter, using On Board clock	
Period	24 ps _{rms} , characteristic
Cycle-to-cycle	43 ps _{rms} , characteristic

Figure 1. Characteristic Period Jitter (RMS) vs. Frequency

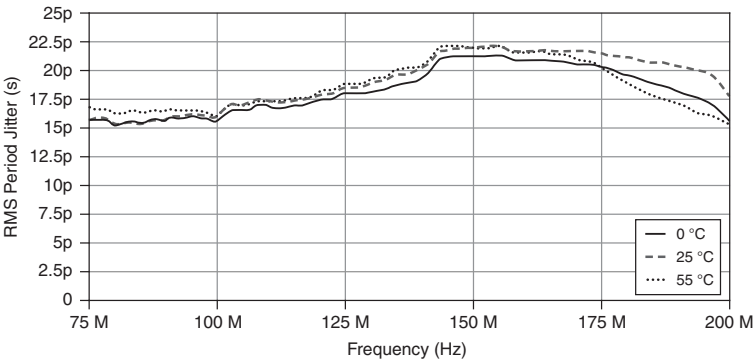


Table 3. Exported Sample Clock Duty Cycle

Logic Family	DDC Clock Out ¹¹	
	Minimum	Maximum
1.2 V	37%	50%
1.5 V	41%	53%
1.8 V	42%	55%
2.5 V	45%	57%
3.3 V	48%	58%

Related Information

[CLK IN](#) on page 15

[STROBE](#) on page 17

¹¹ Does not include the effects of system crosstalk.

Generation Timing

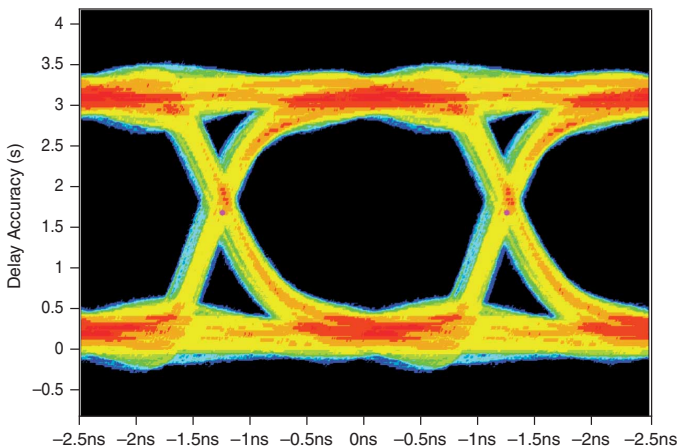
Channels	Data DDC CLK OUT PFI <0..3>
Data channel-to-channel skew ¹²	±300 ps, maximum
Maximum data rate per channel	
SDR	100 Mbps



Note Includes maximum data channel-to-channel skew and typical crosstalk.

The following figure shows an eye diagram of a 400 Mbps pseudorandom bit sequence (PRBS) waveform in DDR mode at 3.3 V. This waveform was captured on DIO 0 at room temperature into high impedance.

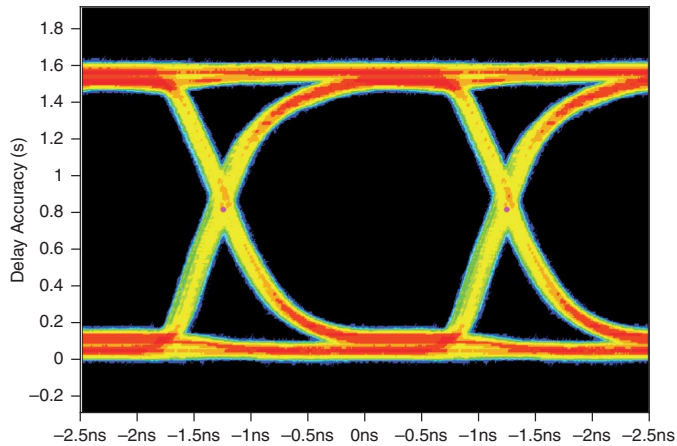
Figure 2. Characteristic Eye Diagram (High Impedance)



The following figure shows an eye diagram of a 400 Mbps PRBS waveform in DDR mode at 3.3 V. This waveform was captured on DIO 0 at room temperature into 50 Ω termination.

¹² Maximum skew across all data channels, PFI channels, and voltage levels when using the same data position or data delay bank.

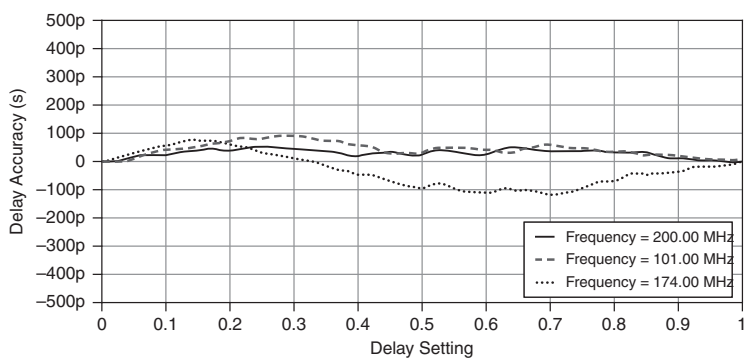
Figure 3. Characteristic Eye Diagram (50 Ω Termination, characteristic)



Data position modes	Sample clock rising edge Sample clock falling edge Delay from Sample clock rising edge
Data delay banks	1 bank for all channels and PFI lines
Generation data delay	
Range (δ_G)	0.0 to 1.0 Sample clock periods
Resolution (δ_G) ¹³	117 ps to 143 ps, nominal
Frequency	
On Board clock	All supported frequencies
External clock	Frequencies ≥ 20 MHz

¹³ Resolution is nonlinearly dependent on clock frequency. You can query resolution using NI-HSDIO.

Figure 4. Characteristic Data Delay Accuracy



Exported Sample clock offset (t_{CO})	0.0 ns or 1.65 ns (default), ¹⁴ nominal
Time delay from On Board Sample clock to DDC connector (t_{SCDDC})	8.1 ns, characteristic; exported Sample clock offset = 0 ns

Generation Provided Setup and Hold Times

Compare the setup and hold times from the datasheet of your device under test (DUT) to the values in the table. The provided setup and hold times must be greater than the setup and hold times required for the DUT. If you require more setup time, configure your exported Sample clock mode to Inverted and/or delay your clock or data relative to the Sample clock. This table includes worst-case effects of channel-to-channel skew and intersymbol interference.

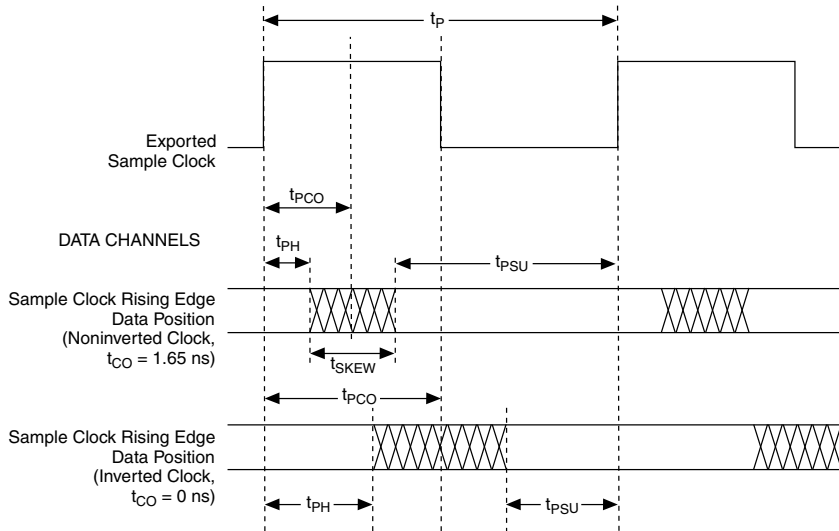
Exported Sample Clock Offset (t_{PCO})	Minimum Provided Setup Time (t_{PSU})	Minimum Provided Hold Time (t_{PH})
1.65 ns	$t_p - 2.15$ ns	1.15 ns
0.0 ns	$t_p - 500$ ps	-500 ps



Note This table assumes the data position is set to Sample clock rising edge and the noninverted Sample Clock is exported to the DDC connector.

¹⁴ Software-selectable for DDC CLK OUT.

Figure 5. Generation Provided Setup and Hold Times Timing Diagram



$$t_P = \frac{1}{f} = \text{Sample Clock Period}$$

t_{PH} = Minimum Provided Hold Time

t_{PSU} = Minimum Provided Set-Up Time

t_{PCO} = Time from Rising Clock Edge to Data Transition (Provided Clock to Out Time)

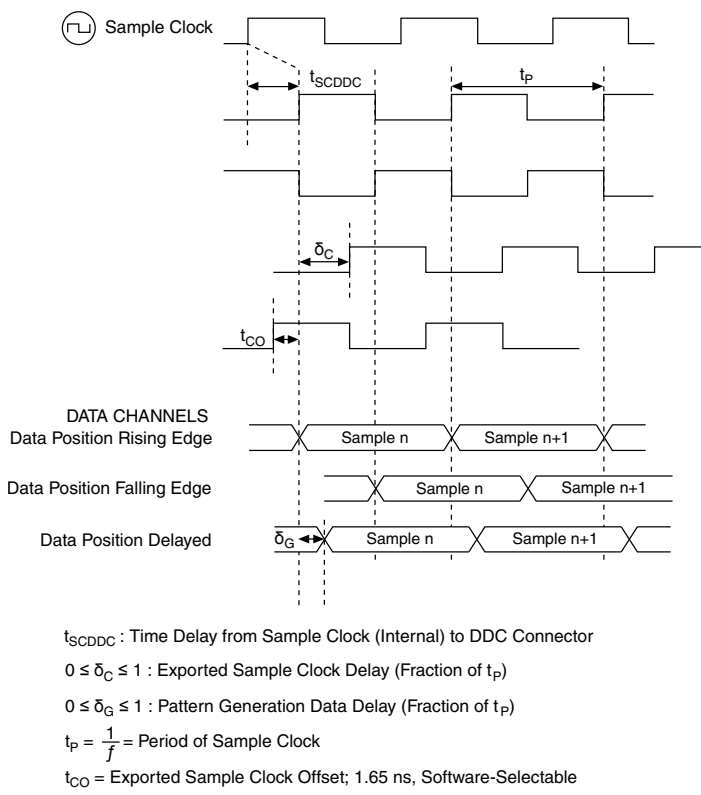
t_{CO} = Exported Sample Clock Offset

t_{SKEW} = Maximum Channel-to-Channel Skew and Clock Uncertainty



Note Provided setup and hold times account for maximum channel-to-channel skew and jitter.

Figure 6. Generation Timing Diagram



Acquisition Timing

Channels	Data STROBE PFI <0..3>
Channel-to-channel skew ¹⁵	±350 ps, maximum
Maximum data rate per channel ¹⁶	
SDR	100 Mbps
Data position modes	Sample clock rising edge Sample clock falling edge Delay from Sample clock rising edge

¹⁵ Across all data channels, PFI channels, and voltage levels.

¹⁶ Includes maximum data channel-to-channel skew and typical crosstalk.

Table 4. Setup and Hold Times to STROBE, Characteristic¹⁷

Voltage Threshold	Setup Time (t_{sus})		Hold Time (t_{hs})	
	$f < 20 \text{ MHz}$	$f \geq 20 \text{ MHz}$	$f < 20 \text{ MHz}$	$f \geq 20 \text{ MHz}$
1.25 V to 1.65 V	2.8 ns	1.15 ns	2.4 ns	900 ps
0.90 V to 1.20 V		1.20 ns		1.00 ns
0.75 V to 0.85 V		1.40 ns		1.10 ns
0.60 V to 0.70 V		1.75 ns		1.25 ns

Setup and hold times to Sample clock¹⁸

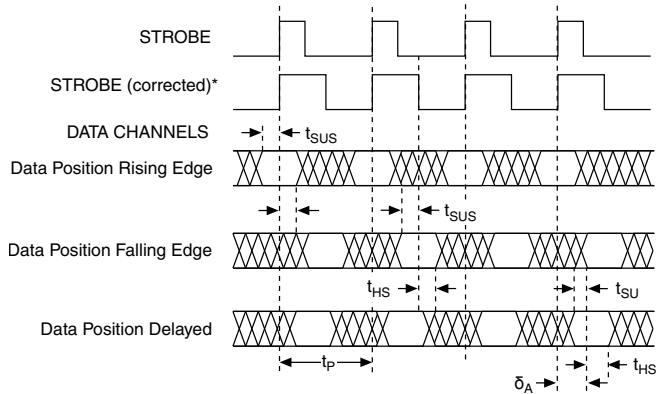
Setup time (t_{susc})	900 ps, nominal
Hold time (t_{HSC})	425 ps, nominal
Data delay banks	1 bank for all channels and PFI lines
Time delay from DDC connector to internal Sample clock	6.8 ns, nominal
Acquisition data delay	
Frequency	
On Board clock	All supported frequencies
External clock and STROBE	Frequencies $\geq 20 \text{ MHz}$
Range	0.0 to 1.0 Sample clock periods
Resolution ¹⁹	117 ps to 143 ps, nominal

¹⁷ Includes maximum data channel-to-channel skew and uncertainty, but does not include system crosstalk. Performance may vary with system crosstalk performance.

¹⁸ Does not include channel-to-channel skew, t_{DDCSC} , or t_{SCDDC}

¹⁹ Resolution is nonlinearly dependent on clock frequency. You can query resolution using NI-HSDIO.

Figure 7. Acquisition Timing Diagram Using STROBE as the Sample Clock



t_{SUS} = Set-Up Time to STROBE

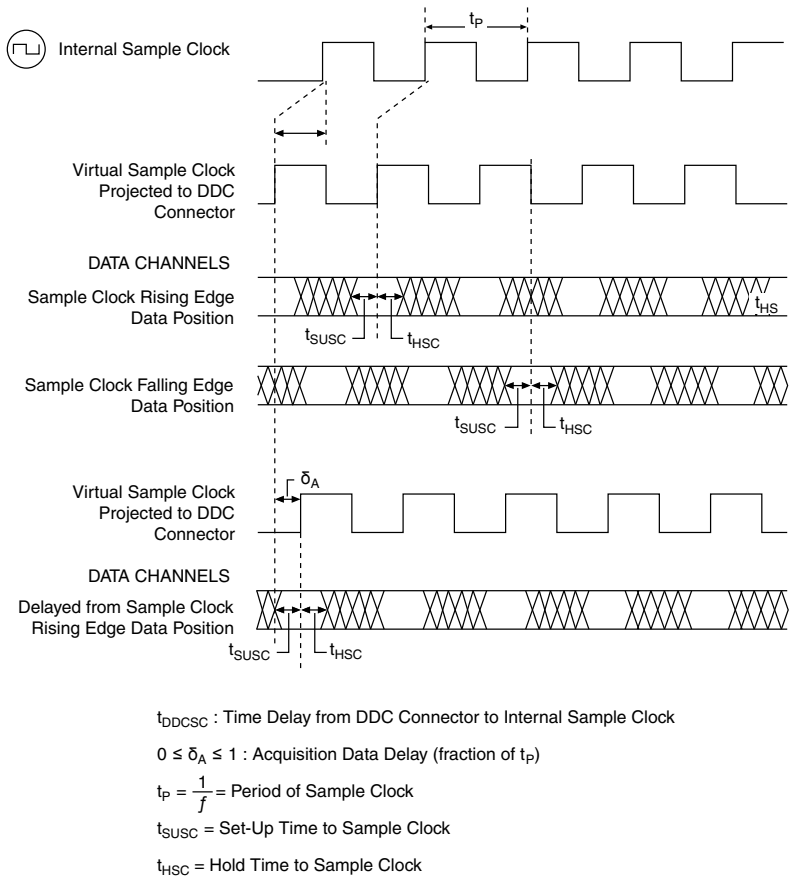
t_{HS} = Hold Time from STROBE

$0 \leq \delta_A \leq 1$: Acquisition Data Delay (fraction of t_p)

$t_p = \frac{1}{f}$ = Sample Clock Period

*Note: When using an external Sample clock greater than 20 MHz, the duty cycle is corrected to 50%.

Figure 8. Acquisition Timing Diagram with Sample Clock Sources Other than STROBE



Related Information

[STROBE](#) on page 17

CLK IN

Connector	SMA jack
Direction	Input
Destinations	1. Reference clock (PLL) 2. Sample clock
Input coupling	AC
Input protection	±10 VDC, nominal

Input impedance	Software-selectable: 50 Ω (default) or 1 k Ω , nominal
Minimum detectable pulse width	2 ns, nominal
Clock requirements	Free-running (continuous) clock
Waveform Voltage Ranges	
Square wave voltage range	0.65 V_{pk-pk} to 5.0 V_{pk-pk}

Table 5. Sine Wave Voltage Ranges

Voltage Range (V_{pk-pk})	Frequency Range
0.65 to 5.0	20 MHz to 200 MHz
1.0 to 5.0	13 MHz to 200 MHz
1.3 to 5.0	10 MHz to 200 MHz
2.6 to 5.0	5 MHz to 200 MHz

CLK IN Implementations

As Sample clock ²⁰	
Frequency range	20 kHz to 200 MHz
Duty cycle range	
$f < 20$ MHz	25% to 75%
$f \geq 20$ MHz	40% to 60%
As Reference clock	
Frequency range	5 MHz to 100 MHz (integer multiples of 1 MHz)
Frequency accuracy ²¹	$\pm 0.1\%$
Duty cycle range	25% to 75%

Related Information

[Channels](#) on page 2
[Sample Clock](#) on page 6

²⁰ Nominal 3 dB cutoff point at 100 MHz when using 1 k Ω input impedance.
²¹ Required accuracy of the external Reference clock source.

STROBE

Connector	DDC
Direction	Input
Destination	Sample clock (acquisition only)
Frequency range	100 Hz to 200 MHz
Duty cycle range (at the programmed threshold)	
$f < 20 \text{ MHz}$	25% to 75%
$f \geq 20 \text{ MHz}$	40% to 60% (corrected to 50%)
Minimum detectable pulse width ²²	2 ns, nominal
Clock requirements	Free-running (continuous) clock
Input impedance	50 k Ω , nominal

Related Information
[Sample Clock](#) on page 6
[Acquisition Timing](#) on page 12

CLK OUT

Connector	SMA jack
Direction	Output
Sources	1. Sample clock (excluding STROBE) 2. Reference clock (PLL)
Output impedance	50 Ω , nominal
Logic type	Matched with generation and acquisition sessions

Related Information
[Channels](#) on page 2
[Generation Channels](#) on page 3

²² Required at acquisition voltage thresholds.

DDC CLK OUT

Connector	DDC
Direction	Output
Source	Sample clock (generation only)



Note STROBE and acquisition Sample clock cannot be routed to DDC CLK OUT.

Related Information
[Generation Channels](#) on page 3

Reference Clock (PLL)

Sources ²³	1. PXI_CLK100 (PXI Express backplane) 2. CLK IN (SMA jack connector) 3. None (internal oscillator locked to an internal reference)
Destination	CLK OUT (SMA jack connector)
Lock time	150 ms, maximum (not including software latency)
Frequency range	5 MHz to 100 MHz (integer multiples of 1 MHz), 0.1% required accuracy
Duty cycle range	25% to 75%

Waveform

Memory and Scripting

Memory architecture	This device uses the Synchronization and Memory Core (SMC) technology in which waveforms and instructions share onboard memory. Parameters such as number of script instructions, maximum number of waveforms in memory, and number of samples (S) available for waveform storage are flexible and user defined.
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²³ Provides the frequency for the PLL.

Onboard memory size²⁴

1 Mbit per channel	
Acquisition	1 Mbit per channel (4 MBytes total)
Generation	1 Mbit per channel (4 MBytes total)
8 Mbit per channel	
Acquisition	8 Mbit per channel (32 MBytes total)
Generation	8 Mbit per channel (32 MBytes total)
64 Mbit per channel	
Acquisition	64 Mbit per channel (256 MBytes total)
Generation	64 Mbit per channel (256 MBytes total)

Generation

Single-waveform mode	Generates a single waveform once, <i>n</i> times, or continuously
Scripted mode ²⁵	Generates a simple or complex sequence of waveforms.
Finite repeat count	1 to 16,777,216
Waveform quantum ²⁶	
Data width = 4	1 sample
Data width = 2	2 samples
Waveform block size (in physical memory)	
Data width = 4	32 samples
Data width = 2	64 samples

Table 6. Generation Minimum Waveform Size²⁷

Configuration	Sample Rate	
	200 MHz	100 MHz
Single waveform	1 S	1 S
Continuous waveform	128 S	64 S

²⁴ Maximum limit for generation sessions assumes no scripting instructions.

²⁵ Use scripts to describe the waveforms to be generated, the order in which the waveforms are generated, how many times the waveforms are generated, and how the device responds to Script Triggers.

²⁶ DDR mode sets data width to 2.

²⁷ Sample rate dependent. Increasing sample rate increases minimum waveform size requirement.

Table 6. Generation Minimum Waveform Size²⁷ (Continued)

Configuration	Sample Rate	
	200 MHz	100 MHz
Stepped sequence	128 S	64 S
Burst sequence	1056 S	512 S

Acquisition	
Minimum waveform size ²⁸	1 S
Record quantum	1 S
Total number of records ²⁹	2,147,483,647
Total pre-Reference trigger samples	0 up to full record
Total post-Reference trigger samples	0 up to full record

Triggers

Types	Sessions	Edge Detection	Level Detection
1. Start	Acquisition and generation	Rising or falling	—
2. Pause	Acquisition and generation	—	High or low
3. Script <0..3>	Acquisition	Rising or falling	High or low
4. Reference	Acquisition	Rising or falling	—

²⁷ Sample rate dependent. Increasing sample rate increases minimum waveform size requirement.
²⁸ Regardless of waveform size, NI-HSDIO allocates at least 640 bytes for a record.
²⁹ The session should fetch quickly enough that unfetched data is not overwritten.

Types	Sessions	Edge Detection	Level Detection
5. Advance	Acquisition	Rising or falling	—
6. Stop	Generation	Rising or falling	—

Sources	1. PFI 0 (SMA jack connector) 2. PFI <1..3> (DDC connector) 3. PXI_TRIG <0..7> (PXI Express backplane) 4. Pattern match (acquisition sessions only) 5. Software (user function call) 6. Disabled (do not wait for a trigger)
Destinations, excluding Pause trigger ³⁰	1. PFI 0 (SMA jack connector) 2. PFI <1..3> (DDC connector) 3. PXI_TRIG <0..6> (PXI Express backplane)
Minimum required trigger pulse width	15 ns
Trigger rearm time	
Start to Reference trigger	150 S, maximum
Start to Advance trigger	220 S, maximum
Advance to Advance trigger	220 S, maximum
Reference to Reference trigger	220 S, maximum
Delay from Pause trigger to Pause state and Stop trigger to Done state ³¹	
Generation sessions	50 Sample clock periods + 300 ns, maximum
Acquisition sessions	Synchronous with the data
Delay from Start trigger and Script trigger to digital data output	3 Sample clock periods + 600 ns, maximum

Related Information

[Channels](#) on page 2

³⁰ Each trigger can be routed to any destination except the Pause trigger. The Pause trigger cannot be exported.

³¹ Use the Data Active event during generation to determine on a sample-by-sample basis when the device enters the Pause or Done states.

Events

Types	Sessions
1. Marker <0..2>	Generation
2. Data Active	Generation
3. Ready for Start	Acquisition and generation
4. Ready for Advance	Acquisition
5. End of Record	Acquisition

Destinations (excluding Data Active event) ³²	1. PFI 0 (SMA jack connectors) 2. PFI <1..3> (DDC connector) 3. PXI_TRIG <0..6> (PXI Express backplane)
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Marker time resolution (placement)	
SDR	Can be placed at any sample
DDR	Must be placed at an integer multiple of two samples

Related Information
[Channels](#) on page 2

Software

Driver Software

Driver support for this device was first available in NI-HSDIO 1.6.

NI-HSDIO is an IVI-compliant driver that allows you to configure, control, and calibrate the PXIe-6545. NI-HSDIO provides application programming interfaces for many development environments.

Application Software

NI-HSDIO provides programming interfaces, documentation, and examples for the following application development environments:

- LabVIEW
- LabWindows™/CVI™
- Measurement Studio

³² The Data Active event can only be routed to the PFI channels.

- Microsoft Visual C/C++
- .NET (C# and VB.NET)

NI Measurement Automation Explorer

NI Measurement Automation Explorer (MAX) provides interactive configuration and test tools for the PXIe-6545. MAX is included on the NI-HSDIO media.

Power



Note Characteristic results are commensurate with an average user application using all data channels into high impedance load. Maximum results include worst-case data pattern.

VDC	Current, Characteristic	Current, Maximum
+3.3 V	1.75 A	1.77 A
+12 V	2.2 A	2.3 A

Total power	32.2 W, characteristic 33.5 W, maximum
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Warm-up time	15 minutes
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Physical

Dimensions	Single 3U, CompactPCI Express slot, PXI Express compatible 21.6 cm × 2.0 cm × 13.0 cm
Weight	519 g (18.3 oz)

I/O Panel Connectors

Label	Connector Type	Description
CLK IN	SMA jack	External Sample clock, external Reference clock
PFI 0		Events, triggers
CLK OUT		External Sample clock, exported Reference clock
DIGITAL DATA & CONTROL	68-pin VHDCI	Digital data channels, exported Sample clock, STROBE, events, triggers

Environment



Note To ensure that the PXIe-6545 cools effectively, follow the guidelines in the *Maintain Forced Air Cooling Note to Users* included with the PXIe-6545 or available at ni.com/manuals. The PXIe-6545 is intended for indoor use only.

Operating temperature	0 °C to 55 °C in all NI PXI Express chassis and hybrid NI PXI Express chassis
Operating relative humidity	10 to 90% relative humidity, noncondensing (meets IEC 60068-2-56)
Storage temperature	-20 °C to 70 °C
Storage relative humidity	5 to 95% relative humidity, noncondensing (meets IEC 60068-2-56)
Operating shock	30 g, half-sine, 11 ms pulse (meets IEC 60068-2-27; test profile developed in accordance with MIL-PRF-28800F)
Operating vibration	5 Hz to 500 Hz, 0.31 g _{rms} (meets IEC 60068-2-64)
Storage shock	50 g, half-sine, 11 ms pulse (meets IEC 60068-2-27; test profile developed in accordance with MIL-PRF-28800F)
Storage vibration	5 Hz to 500 Hz, 2.46 g _{rms} (meets IEC 60068-2-64; test profile exceeds requirements of MIL-PRF-28800F, Class B)

Altitude	0 to 2,000 m above sea level (at 25 °C ambient temperature)
Pollution degree	2

Compliance and Certifications

Safety

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1



Note For UL and other safety certifications, refer to the product label or the [Online Product Certification](#) section.

Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- EN 55022 (CISPR 22): Class A emissions
- EN 55024 (CISPR 24): Immunity
- AS/NZS CISPR 11: Group 1, Class A emissions
- AS/NZS CISPR 22: Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions



Note In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia, and New Zealand (per CISPR 11), Class A equipment is intended for use only in heavy-industrial locations.



Note Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.



Note For EMC declarations, certifications, and additional information, refer to the [Online Product Certification](#) section.



Caution Refer to the *Read Me First: Safety and Electromagnetic Compatibility* document for important safety and electromagnetic compatibility information. To

obtain a copy of this document online, visit ni.com/manuals and search for the document title.



Caution To ensure the specified EMC performance, operate this product only with shielded cables and accessories. Do not use unshielded cables or accessories unless they are installed in a shielded enclosure with properly designed and shielded input/output ports and connected to the product using a shielded cable. If unshielded cables or accessories are not properly installed and shielded, the EMC specifications for the product are no longer guaranteed.



Note SHC68-C68-D4 shielded cable and the provided snap-on ferrite beads, National Instruments part number 711627-01, must be used when operating the PXIe-6545.



Caution To ensure the specified EMC performance, the length of all I/O cables must be no longer than 3 m (10 ft).



Caution To ensure the specified EMC performance, you must install PXI EMC Filler Panels, National Instruments part number 778700-01, in all open chassis slots.

CE Compliance

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)

Online Product Certification

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for this product, visit ni.com/certification, search by model number or product line, and click the appropriate link in the Certification column.

Environmental Management

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Waste Electrical and Electronic Equipment (WEEE)



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